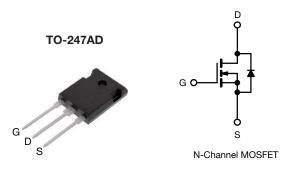
# SQW61N65EF



**Vishay Siliconix** 

# Automotive E Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700			
R <sub>DS(on)</sub> typ. at 25 °C (Ω)	$V_{GS} = 10 V$	0.045		
Q <sub>g</sub> typ. (nC)	229			
Q <sub>gs</sub> (nC)	53			
Q <sub>gd</sub> (nC)	91			
Configuration	Single			



### FEATURES

- Fast body diode MOSFET using Automotive Grade E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- $\bullet$  Low switching losses due to reduced  $\mathsf{Q}_{\mathsf{rr}}$
- 175 °C operating temperature
- AEC-Q101 qualified
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Automotive onboard charger
- Automotive DC/DC converter

ORDERING INFORMATION			
Package	TO-247AD		
Lead (Pb)-Free and Halogen-Free	SQW61N65EF-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	650	V	
Gate-Source Voltage			V <sub>GS</sub>	± 30	v	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	62		
		T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		44	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	187		
Linear Derating Factor				4.2	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1323	mJ	
Maximum Power Dissipation			PD	625	W	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Drain-Source Voltage Slope			dV/dt	70	\//==	
Reverse Diode dV/dt <sup>d</sup>				50	V/ns	
Soldering Recommendations (Peak temperature) <sup>c</sup>	For	10 s		260	°C	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 73.5 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 470 A/µs, starting  $T_J$  = 25 °C

1 For technical questions, contact: <u>hvm@vishay.com</u>



RoHS

COMPLIANT



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.24	0/ W		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$		650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 30 mA	-	0.77	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$		-	-	± 100	nA
			$V_{GS} = \pm 30 \text{ V}$		-	± 1	μA
		V <sub>DS</sub> =	V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V		-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 32 A	-	0.045	0.052	Ω
Forward Transconductance		V <sub>DS</sub> = 30 V, I <sub>D</sub> = 32 A		-	28	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	7379	-	pF
Output Capacitance	Coss			-	310	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	4	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 520 V, V <sub>GS</sub> = 0 V		-	213	-	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	841	-	
Total Gate Charge	Qg			-	229	344	
Gate-Source Charge	Q <sub>qs</sub>	V <sub>GS</sub> = 10 V	V <sub>GS</sub> = 10 V I <sub>D</sub> = 32 A, V <sub>DS</sub> = 520 V		53	-	nC
Gate-Drain Charge	Q <sub>gd</sub>			-	91	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				65	98	- ns
Rise Time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{DD} = 520 \; V, \; I_{D} = 32 \; A, \\ V_{GS} = 10 \; V, \; R_{g} = 9.1 \; \Omega \end{array}$		-	107	161	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	252	378	
Fall Time	t <sub>f</sub>		1		102	153	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.5	1	2	Ω
Drain-Source Body Diode Characteristics	6	•			•	•	
Continuous Source-Drain Diode Current	IS	MOSFET sym showing the	MOSFET symbol		-	62	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	187	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 32 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 30.5 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 400 V		-	204	408	ns
Reverse Recovery Charge	Q <sub>rr</sub>			-	1.9	3.8	μC
Reverse Recovery Current	I <sub>BBM</sub>			-	18	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

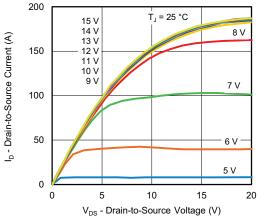


Fig. 1 - Typical Output Characteristics

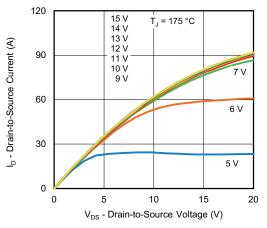


Fig. 2 - Typical Output Characteristics

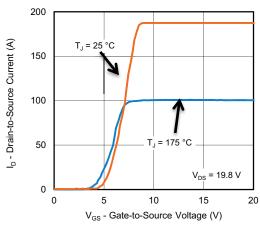


Fig. 3 - Typical Transfer Characteristics

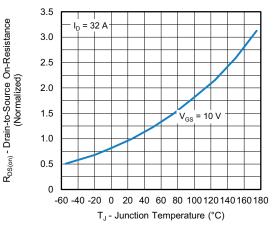


Fig. 4 - Normalized On-Resistance vs. Temperature

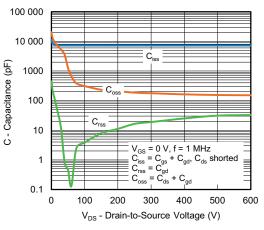
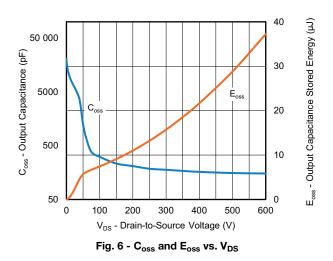


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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3 For technical questions, contact: <u>hvm@vishav.com</u> Document Number: 92303

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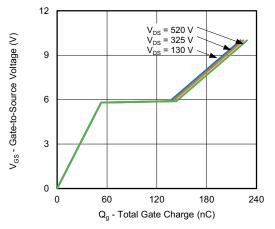


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

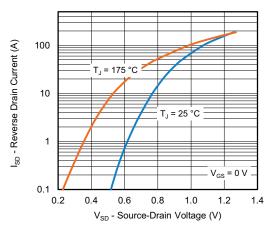
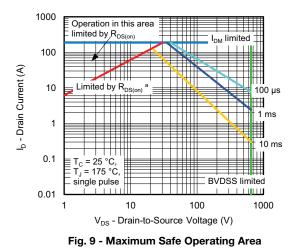


Fig. 8 - Typical Source-Drain Diode Forward Voltage



Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

S20-0874-Rev. A, 16-Nov-2020

4

(Y) true - 0 = 0 = 0

Fig. 10 - Maximum Drain Current vs. Case Temperature

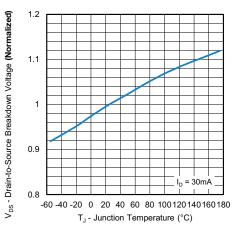


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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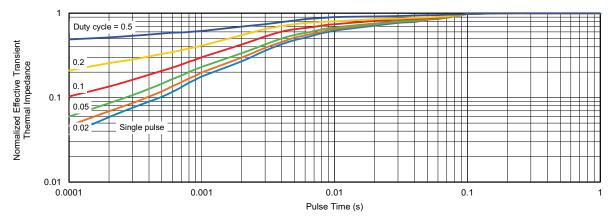


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

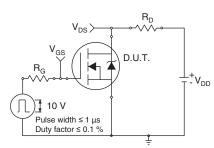


Fig. 13 - Switching Time Test Circuit

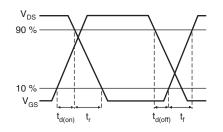


Fig. 14 - Switching Time Waveforms

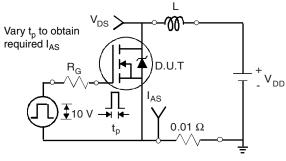


Fig. 15 - Unclamped Inductive Test Circuit

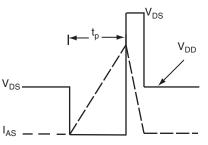


Fig. 16 - Unclamped Inductive Waveforms

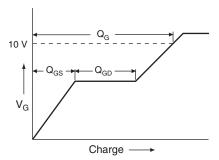


Fig. 17 - Basic Gate Charge Waveform

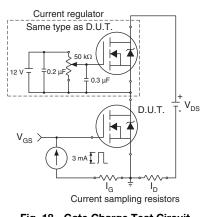


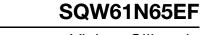
Fig. 18 - Gate Charge Test Circuit

S20-0874-Rev. A, 16-Nov-2020

5

Document Number: 92303

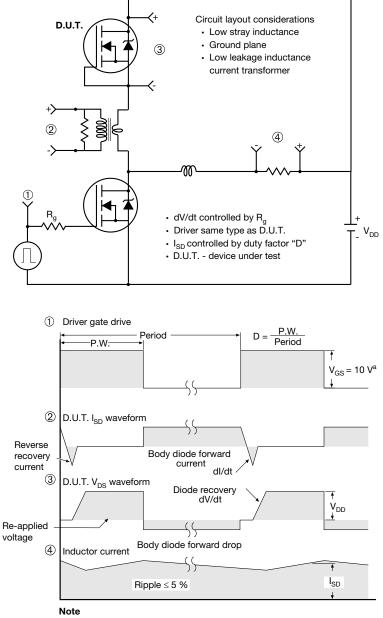
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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